



MODEL NO :	TM080TDGP01
MODEL VERSION:	00
SPEC VERSION:	2.3
ISSUED DATE:	2020-09-28

□ Preliminary Specification **■Final Product Specification** 

Customer:

Notes

### **TIANMA Confirmed:**

Prepared by	Checked by	Approved by
Liang_ming	Runnan_kong Huiping_qing Wenyi_li Wei_guo	Guangkun_an

This technical specification is subjected to change without notice





#### Model No. TM080TDGP01-00

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# **Record of Revision**

Rev	Issued Date	Description	Editor
1.0	2019-01-07	Preliminary Specification Release	Haiping_luo
2.0	2019-06-10	Change contrast Ratio ,luminance, Power ON/OFF Sequence	Liang_ming
2.1	2019-08-28	Change luminance	Liang_ming
2.2	2020-02-28	Final Product Specification Release	Liang_ming
2.3	2020-09-28	Add Power Consumption	Liang_ming
	4		



# 1 General Specifications

	Feature	Spec	
	Size	8 inch	
	Resolution	1024RGB×768	
	Technology Type	a-Si	
Display Spec.	Pixel Configuration	R.G.B. Stripe	
Display Spec.	Pixel pitch(mm)	0.158(H) ×0.158(V)	
	Display Mode	SFT	
	Surface Treatment	HC	
	Viewing Direction	All	
	LCM (W x H x D) (mm)	183.43×138.35×3.75	
	Active Area(mm)	162.05 × 121.54	
Mechanical	With /Without TSP	Without TSP	
Characteristics	Matching Connection Type	ZIF	
	LED Numbers	27 LEDS	
	Weight (g)	TBD	
Floridation	Interface	LVDS	
Electrical Characteristics	Color Depth	16.7M	
	Driver IC	RM51150+HX8684B	

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: ± 5%



# **Input/Output Terminals**

			Matched connector:FH12A-40	
Pin No.	Symbol	I/O	Function	Remark
1	NC	-	No connection	
2	VDD	P	Power Voltage for digital circuit	
3	VDD	P	Power Voltage for digital circuit	
4	NC		No connection	
5	RESET	I	Global reset pin	
6	STBYB	I	Standby mode, Normally pulled high STBYB = "1", normal operation STBYB = "0", timing controller, source driver will turn off, all output are GND	
7	GND	P	Ground	
8	RXIN0-	I	- LVDS differential data input	
9	RXIN0+	I	+ LVDS differential data input	R[0]~G[0]
10	GND	P	Ground	
11	RXIN1-	I	- LVDS differential data input	
12	RXIN1+	I	+ LVDS differential data input	G[1]~B[1]
13	GND	P	Ground	
14	RXIN2-	I	- LVDS differential data input	
15	RXIN2+	I	+ LVDS differential data input	DE/VS/HS/ B[2]~B[5]
16	GND	P	Ground	
17	RXCLKIN-	I	- LVDS differential clock input	
18	RXCLKIN +	I	+ LVDS differential clock input	
19	GND	P	Ground	
20	RXIN3-	I	- LVDS differential data input	
21	RXIN3+	I	+ LVDS differential data input	R[6]/R[7]/G[ 6]/G[7]/B[6]/ B[7]
22	GND	P	Ground	
23	NC		No connection	
24	NC		No connection	
25	GND	P	Ground	
26	NC		No connection	
27	DIMO	О	Backlight CABC controller signal output	Note1
28	SELB	Ι	6bit/8bit mode select Pin	Note2
29	AVDD	P	Power for Analog Circuit	
30	GND	P	Ground	
31	LED-	P	LED Cathode	
32	LED-	P	LED Cathode	
33	L/R	I	Horizontal Scanning direction setting	Note3
34	U/D	Ι	Vertical Scanning direction setting	Note3
35	VGL	P	Gate OFF Voltage	
36	CABCEN1	I	CABC H/W enable pin	Note4
37	CABCEN0	I	CABC H/W enable pin	Note4

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38	VGH	P	Gate ON Voltage	
39	LED+	P	LED Anode	
40	LED+	P	LED Anode	

I/O----definition, I----Input, O----Output, P----Power, No used I/O pin please fix to GND level

Note1: PWM output after CABC function;

Note2: LVDS mode 6bits/8bits input select pin,If LVDS input data in 6 bits,SELB must be set To high, If LVDS input data in 8 bits, SELB must be set to low,

Note3: When L/R="0",set right to left scan direction, L/R="1" set left to right scan direction, source IC@6 o'clock.

When U/D="0", set top to bottom scan direction, U/D="1" set bottom to top scan direction, source IC@6 o'clock.

#### Note4:

CABC_EN[1:0] I	CABC H/W enable pin. Normally pull low. When CABC_EN="00", CABC off. (Default mode) When CABC_EN="01", user interface Image. When CABC_EN="10", still Picture. When CABC_EN="11", moving Image.
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# 3 Absolute Maximum Ratings

GND=0V

Item	Symbol	MIN	MAX	Unit	Remark	
Power Voltage	VDD	-0.3	5.0	V	Note1	
Power Supply Voltage 2	AVDD	-0.5	13.5	V	Base on IC Spec	
Power Supply Voltage 3	VGH	-0.3	VGL+42	V	Base on IC Spec	
Power Supply Voltage 4	VGL	-25	+0.3	V	Base on IC Spec	
Operating Temperature	Тор	-20	70	$^{\circ}$		
Storage Temperature	Tst	-30	80	$^{\circ}$ C		
			≤95	%	Ta≶40°C	
Dalatha Handidte			≤85	%	40°C < Ta ≤ 50°C	
Relative Humidity Note2	RH		≤55	%	50°C <ta≤60°c< td=""></ta≤60°c<>	
Notez			≤36	%	60°C < Ta ≤ 70°C	
			≤24	%	70°C <ta≤80°c< td=""></ta≤80°c<>	
Absolute Humidity	AH		≤70	g/m³	Ta>70°C	

 Table 3
 Absolute Maximum Ratings

 $Note 1: Input \ voltage \ include \ RESET \ , STBYB \ , SELB \ , L/R \ , U/D, \ CABCEN 1, \ CABCEN 0.$ 

Note2: Ta means the ambient temperature.

It is necessary to limit the relative humidity to the specified temperature range. Condensation on the module is not allowed.



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### **Electrical Characteristics**

### **Recommended Operating Condition**

AGND=GND=0V, Ta =  $25^{\circ}$ C

Item	Symbol	Min	Тур.	Max	Unit	Remark
Digital Supply Voltage	VDD	3.2	3.3	3.4	V	-
Analog Supply Voltage	AVDD	12.4	12.6	12.8	V	-
Gate On Voltage	VGH	22.0	23.0	24.0	V	-
Gate Off Voltage	VGL	-7.5	-7.0	-6.5	V	-
Low level input voltage	VIL	0		0.3*VDD	V	
High level input voltage	VIH	0.7*VDD		VDD	V	
Low level output voltage	VOL	0		GND+0.4	V	
High level output voltage	VOH	VDD-0.4		VDD	V	

#### 4.2 Power Consumption

AGND=GND=0V, Ta = 25°C

				,			
Item	Symbol	Condition	Min	Тур.	Max	Unit	Remark
Digital Supply Current	I <sub>VCC</sub>	VDD=3.3V		19.3	-	mA	Note1
Analog Supply Current	I <sub>AVDD</sub>	AVDD=12.6V	-	57	-	mA	Note1
Gate On Current	$I_{VGH}$	VGH=23.0V	-	0.65	-	mA	Note1
Gate Off Current	I <sub>VGL</sub>	VGL=-7.0V	-	0.65	-	mA	Note1
Power Consumption		Р	-	801	1200	mW	Note1

Note1: Test condition:VDD=3.3V, AVDD=12.6V, VGH=23.0V, VGL=-7.0V, white pattern. Actual power consumption is based on actual measurement.



### 4.3 Recommended Driving Condition for Backlight

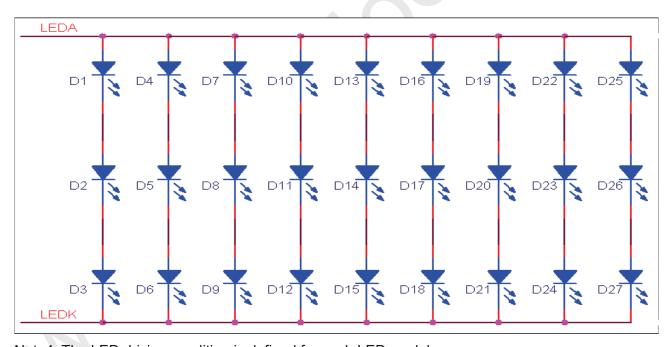
Ta=25℃

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	I <sub>F</sub>	-	180	225	mA	27LEDs
Forward Voltage	V <sub>F</sub>	8.4	9.3	10.2	V	(3 LED Serial, 9
Backlight Power Consumption	$W_{BL}$	-	1.674	2.295	W	LED Parallel)
Operating Life Time	-	20,000	30,000	-	Hrs	I <sub>F</sub> =20mA

Note1: The LED driving condition is defined for each LED module (3 LED Serial, 9 LED Parallel). For each LED:  $I_F$  (1/9) =20mA,  $V_F$  (1/3) =3.1V.

Note2: Under LCM operating, the stable forward current should be inputted. And forward voltage is for reference only.

Note3:  $I_F$  is defined for one channel LED.Optical performance should be evaluated at Ta=25°C only If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced.Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.

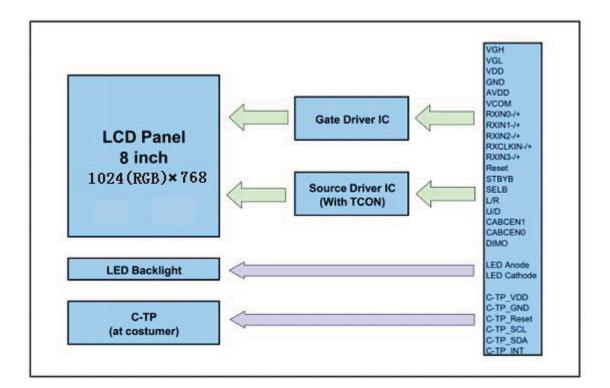


Note4: The LED driving condition is defined for each LED module





### 4.4 Block Diagram



LCD module diagram

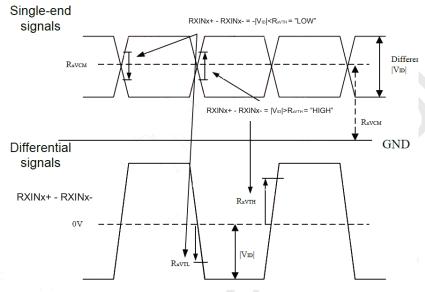


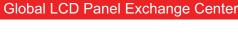


# 5 Timing Chart

#### 5.1 LVDS mode DC electrical characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Differential Input high Threshold	Rxvтн	-	-	+0.2	V	Rxvcm=1.2V
voltage						
Differential Input Low Threshold	RXVTL	-0.2	-	-	V	
voltage						
Input voltage range	Rxvin	0	-	VDD-1.2	V	- /
(signaled-end)						
Differential Input common Mode	Rxvcм	V <sub>ID</sub>  /2	-	VDD-1.2-	V	- \\ >
voltage				V <sub>ID</sub>  /2		
Differential Input voltage	V <sub>ID</sub>	0.2	-	0.6	V	7 //
Differential Input leakage Current	RVxliz	-10	-	+10	uA	-\\
LVDS Digital Operating Current	Iddlvds	-	15	30	mA	Fclk=65MHz, VDD=3.3V
LVDS Digital Stand-by Current	Istlvds	-	10	50	uА	Clock & all functions are
_						stopped



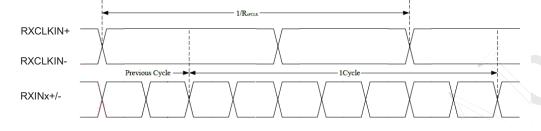


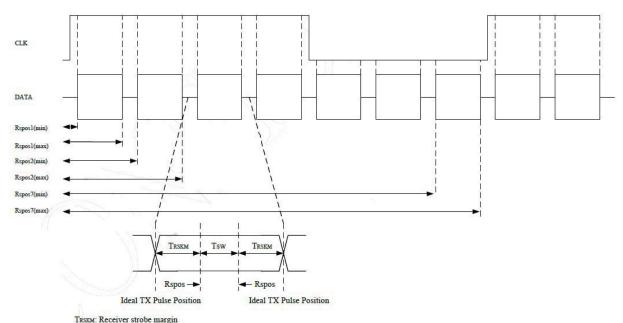
**TIANMA** 

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### 5.2 LVDS mode AC electrical characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Clock frequency	Rxfclk	20	-	71	Mhz	
Input data skew margin	Тязкм	-	-	500	ps	Vid =400mV Rxvom=1.2V Rxfclk=71MHz
Clock high time	TLVCH	-	4/(7*RXFCLK)	-	ns	
Clock low time	TLVCL	-	3/(7*RXFCLK)	-	ns	





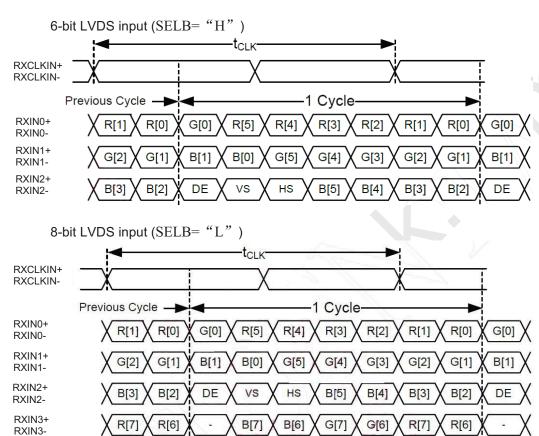
Rspos: Receiver strobe position Tsw: Strobe width (internal data sampling window)

Parameter	Symbol	IVIIN.	тур.	Max.	Unit	Condition
Modulation Frequency	SSCMF	23	-	93	KHz	
Modulation Rate	SSCMR	-	-	±3	%	LVDS clock = 71MHz center spread
						•





#### 5.3 Data input format 5.3.1 LVDS data mapping



#### 5.3.2 Parallel RGB input timing table

#### DE mode

Parameter	Symbol		Unit		
	Symbol	Min.	Тур.	Max.	
DCLK Frequency	fclk	52	65	71	MHz
Horizontal Display Area	thd		DCLK		
HSD Period	th	1114	1344	1400	DCLK
HSD Blanking	thb+thfp	90	320	376	DCLK
Vertical Display Area	tvd		Тн		
VSD Period	tvbp	778	806	845	Тн
VSD Blanking	tvbp+tvfp	10	38	77	Тн

**②** 

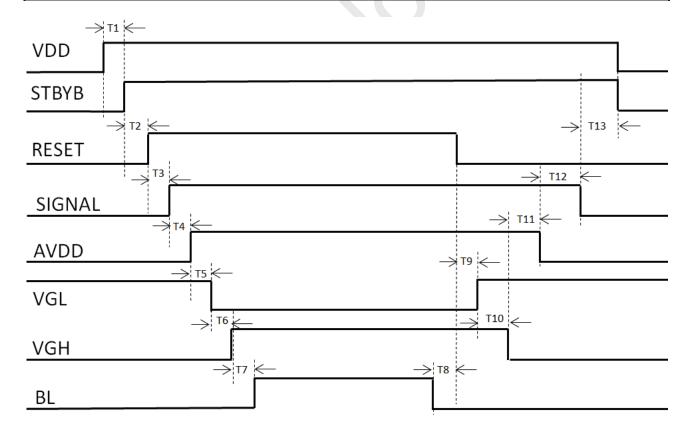




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### 5.4 Power ON/OFF Sequence

Item	Symbol	MIN	Тур	MAX	Unit	Remark
VDD on 10% to 90%	T0	1		20	ms	
VDD on to Standby off(Standby is high)	T1	1	-	-	ms	
Standby off to Reset signal on	T2	0	-	ı	ms	
Reset signal to Display signal on	Т3	1	-	-	ms	
Display signal to AVDD on	T4	67	-	ı	ms	
AVDD on to VGL on	T5	16.7	-	ı	ms	
VGL on to VGH on	T6	16.7	-	-	ms	
VGH on to B/L on	T7	200	-	-	ms	
B/L off to Standby on	T8	500	-	-	ms	
Standby on to VGL off	Т9	83.5	-	-	ms	
VGL off to VGH off	T10	16.7	-	-	ms	
VGH off to AVDD off	T11	16.7	-	1	ms	
AVDD off to Display signal off	T12	16.7	-	-	ms	_
Display signal off to VDD and Reset off	T13	16.7		-	ms	





# 6 Optical Characteristics

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	
View Angles Contrast Ratio		θТ		75	85	-			
		θВ	CR≧10	75	85	-	5	NI-4-0.0	
		θL	T CR≦ IU	75	85	-	Degree	Note2,3	
		θR		75	85	-			
		CR	θ=0°	1500	1800	-		Note 3	
Posnonso Tim		T <sub>ON</sub>	25℃		35	45	ms	Note 4	
Response Time		T <sub>OFF</sub>	25 (	-	35	45	IIIS	11016 4	
	White	Х	Backlight is on	0.251	0.310	0.351		Note 1,5	
	vviiite	У		0.279	0.329	0.379			
	Red	х		0.537	0.587	0.637			
Chromaticity	Neu	У		0.280	0.330	0.380			
Omomaticity	Green	х		0.308	0.358	0.408		Note 1,5	
	Oreen	У		0.536	0.586	0.636			
	Blue	х		0.106	0.156	0.206		Note 1,5	
	Dide	У		0.048	0.098	0.148		INULE I,U	
Uniformity		U		80	85		%	Note 6	
NTSC				45	50		%	Note 5	
Luminance				400	450		cd/m <sup>2</sup>	Note 7	

#### **Test Conditions:**

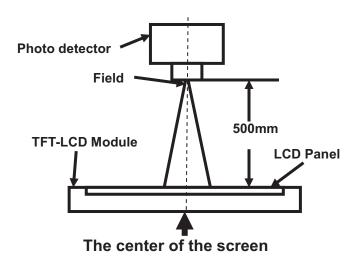
- 1. IF= 180 mA, and the ambient temperature is  $25^{\circ}$ C.
- 2. The test systems refer to Note 1 and Note 2.





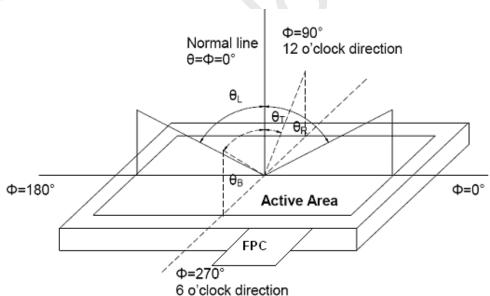
Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 Minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD.



Definition of contrast ratio Note 3:

Luminance measured when LCD is on the "White" state Contrast ratio (CR) = Luminance measured when LCD is on the "Black" state

"White state ": The state is that the LCD should drive by Vwhite.

"Black state": The state is that the LCD should drive by Vblack.

Vwhite: To be determined Vblack: To be determined.

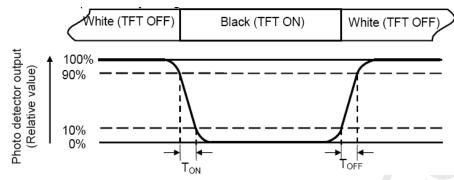




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Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T<sub>ON</sub>) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T<sub>OFF</sub>) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

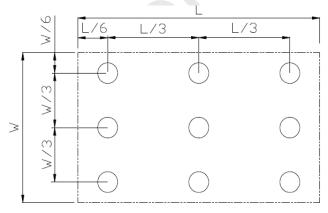
Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = Lmin/Lmax

L-----Active area length W----- Active area width



Lmax: The measured Maximum luminance of all measurement position.

Lmin: The measured Minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.





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# **Environmental / Reliability Test**

No	Test Item	Condition	Remarks
1	High Temperature Operation	Ta = +70℃, 240 hours (Note1)	IEC60068-2-1:2007 GB2423.2-2008
2	Low Temperature Operation	Ta = -20°C, 240 hours (Note2)	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Storage	Ta = +80°C, 240 hours	IEC60068-2-1:2007 GB2423.2-2008
4	Low Temperature Storage	Ta = -30℃, 240 hours	IEC60068-2-1:2007 GB2423.1-2008
5	Storage at High Temperature and Humidity	Ta = +60℃, 90% RH max, 240hours	IEC60068-2-78 :2001 GB/T2423.3—2006
6	Thermal Shock (non-operation)	-30°C 30 min ~ +80°C 30 min, Change time:5min, 100 Cycle	Start with cold temperature, End with high temperature, IEC60068-2-14:1984,G B2423.22-2002
7	ESD	C=150pF, R=330Ω, 5point/panel Air: ±8Kv, 5times; Contact: ±4Kv, 5times (Environment: 15°C~35°C, 30%~60%. 86Kpa~106Kpa)	IEC61000-4-2:2001 GB/T17626.2-2006
8	Vibration Test	5Hz~20Hz~200Hz, 0.01g2/Hz~0.01g2/Hz~0.001g2/Hz,X/Y/Z 各轴 30min	GB/T 4857.23-2012
9	Package Drop Test	Drop 1 corner, 3 edges, 6 surfaces from height of 80cm (Weight≦10kg); of 60 cm (Weight>10kg)	GB/T 4857.5-1992

Note1: Ta is the ambient temperature of sample.

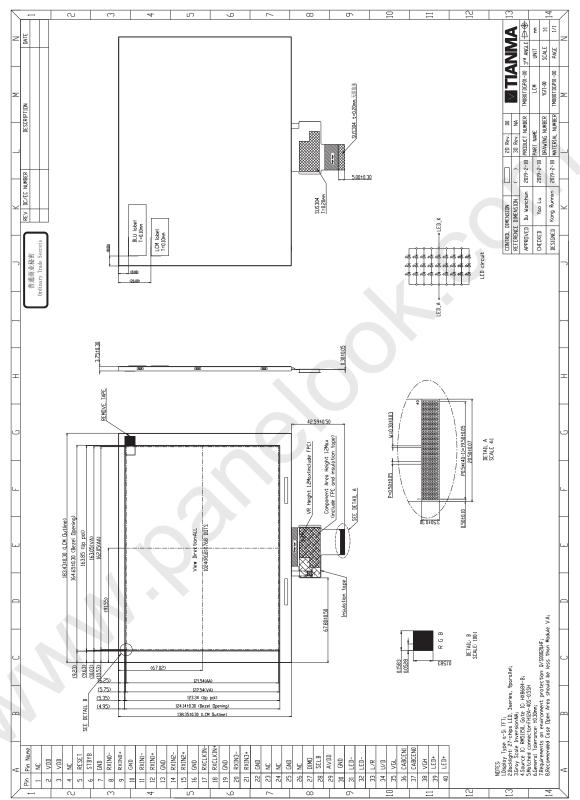
Note2: Before cosmetic and function test, the product must have enough recovery time, at least 24 hours at room temperature.

Note 3: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.





# 8 Mechanical Drawing







# 9 Packing Drawing

### 9.1 Packaging Material

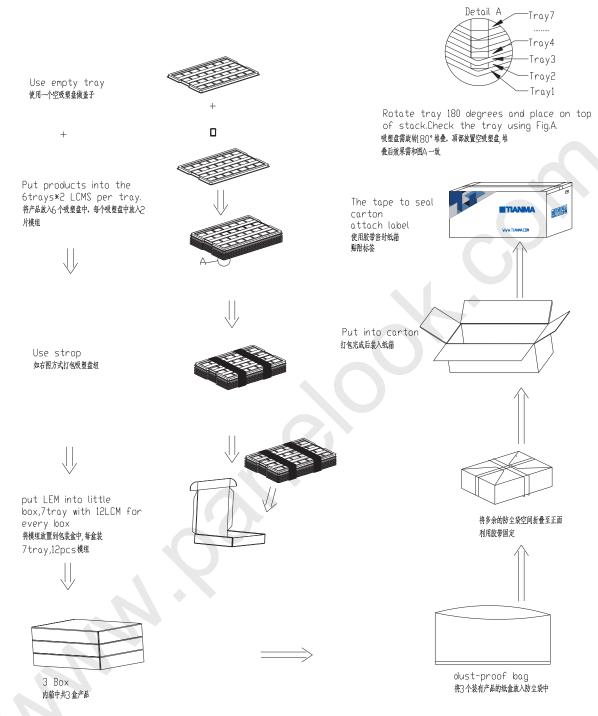
#### **Per Carton**

No	Item	Model (Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark			
1	LCM module	TM080TDGP01-00	183.43×138.35×3.75	0.180	36				
2	Tray	PET	485×330×1.0	0.18	21				
3	Dust-proof Bag	PE	700×545×0.05	0.021	1				
4	Carton	Corrugated Paper	544×365×250	1.01	1				
5	вох	Corrugated Paper	520×345×74	0.227	3				
6	Label	paper	100×52	0.001	1				
7	EPE	EPE	485×330×5	0.05	3				
8	Total weight		12.1						



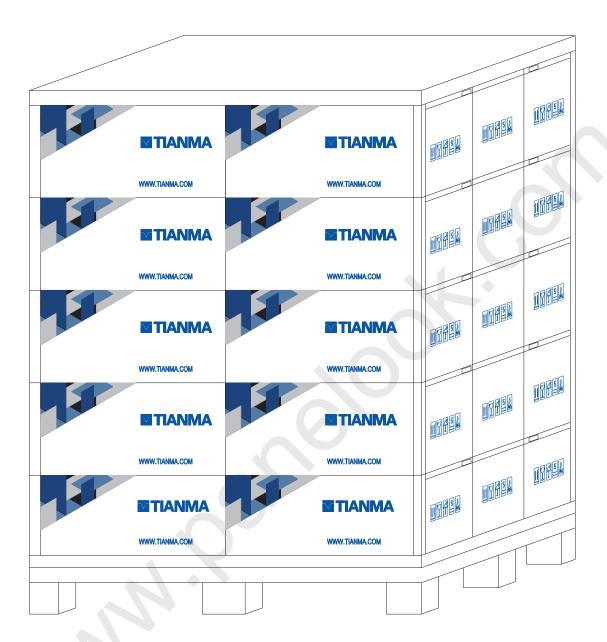


# 9.2 Packing instruction













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### **Precautions for Use of LCD Modules**

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to varv.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaMinated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
  - Isopropyl alcohol
  - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
  - 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
- 10.2 Storage precautions
  - 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:
- Temperature :  $0^{\circ}$ C  $\sim 40^{\circ}$ C Relatively humidity:  $\leq 80\%$ 
  - 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 **Transportation Precautions**

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The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

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